

FEATURES

- Controlled Baseline
 - One Assembly/Test Site, One Fabrication Site
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product-Change Notification
- Qualification Pedigree (1)
- Operates From 1.65 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max t_{pd} of 6.3 ns at 3.3 V
- Typical V_{OLP} (Output Ground Bounce) <0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot) >2 V at V_{CC} = 3.3 V, T_A = 25°C
- I_{off} Supports Partial-Power-Down Mode Operation
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V_{cc})
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- (1) Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

DESCRIPTION/ORDERING INFORMATION

This octal bus transceiver is designed for 1.65-V to 3.6-V V_{CC} operation.

The SN74LVC245A is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so the buses are effectively isolated.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of this device as a translator in a mixed 3.3-V/5-V system environment.

ORDERING INFORMATION

T _A	PACKA	GE ⁽¹⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING		
–40°C to 85°C	TSSOP – PW	Reel of 2000	SN74LVC245AIPWREP	C245AEP		

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

SCAS741B-DECEMBER 2003-REVISED AUGUST 2005

- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 1000-V Charged-Device Model (C101)

Ρ		PACK		_
DIR [1	υ	20	Vcc
A1 [2		19] OE
A2 [3		18] B1
A3 [4		17	B2
A4 [5		16] B3
A5 [6		15	B4
A6 [7		14	B5
A7 [8		13] B6
A8 [9		12	B7
GND [10		11] в8

SN74LVC245A-EP OCTAL BUS TRANSCEIVER WITH 3-STATE OUTPUTS

TEXAS INSTRUMENTS www.ti.com

SCAS741B-DECEMBER 2003-REVISED AUGUST 2005

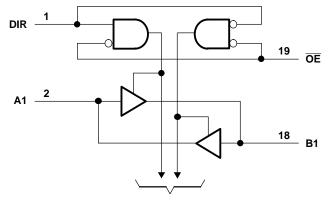
DESCRIPTION/ORDERING INFORMATION (CONTINUED)

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

FUNCTION TABLE

INP	UTS	OPERATION
OE	DIR	OPERATION
L	L	B data to A bus
L	Н	A data to B bus
н	Х	Isolation

LOGIC DIAGRAM (POSITIVE LOGIC)



To Seven Other Channels

Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V _{CC}	Supply voltage range		-0.5	6.5	V
VI	Input voltage range ⁽²⁾		-0.5	6.5	V
Vo	Voltage range applied to any output in th	e high-impedance or power-off state ⁽²⁾	-0.5	6.5	V
Vo	Voltage range applied to any output in th	e high or low state ⁽²⁾⁽³⁾	-0.5	V _{CC} + 0.5	V
I _{IK}	Input clamp current	V ₁ < 0		-50	mA
I _{OK}	Output clamp current	V _O < 0		-50	mA
I _O	Continuous output current			±50	mA
	Continuous current through V_{CC} or GND			±100	mA
θ_{JA}	Package thermal impedance ⁽⁴⁾		83	°C/W	
T _{stg}	Storage temperature range		-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

(3) The value of V_{CC} is provided in the recommended operating conditions table.

(4) The package thermal impedance is calculated in accordance with JESD 51-7.

Recommended Operating Conditions⁽¹⁾

			T _A = 2	25°C	–40°C to	o 85°C	UNIT
			MIN	MAX	MIN	MAX	UNIT
V	Supply voltoge	Operating	1.65	3.6	1.65	3.6	V
V _{CC}	Supply voltage	Data retention only	1.5		1.5		v
		V_{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$		$0.65 imes V_{CC}$		
V _{IH}	High-level input voltage	$V_{\rm CC}$ = 2.3 V to 2.7 V	1.7		1.7		V
		V_{CC} = 2.7 V to 3.6 V	2		2		
		V_{CC} = 1.65 V to 1.95 V		$0.35 \times V_{CC}$		$0.35 imes V_{CC}$	
V _{IL}	Low-level input voltage	V_{CC} = 2.3 V to 2.7 V		0.7		0.7	V
	Input voltage	V_{CC} = 2.7 V to 3.6 V		0.8		0.8	
VI	Input voltage		0	5.5	0	5.5	V
Vo	Output voltage		0	V _{CC}	0	V _{CC}	V
		V _{CC} = 1.65 V		-4		-4	
	High-level output current	V_{CC} = 2.3 V		-8		-8	mA
I _{OH}		$V_{CC} = 2.7 V$		-12		-12	ШA
		$V_{CC} = 3 V$		-24		-24	
		V _{CC} = 1.65 V		4		4	
	Low lovel output ourrent	$V_{CC} = 2.3 V$		8		8	mA
I _{OL}	Low-level output current	$V_{CC} = 2.7 V$		12		12	ША
		$V_{CC} = 3 V$		24		24	
$\Delta t/\Delta v$	Input transition rise or fall rate			10		10	ns/V

 All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

SN74LVC245A-EP **OCTAL BUS TRANSCEIVER** WITH 3-STATE OUTPUTS

SCAS741B-DECEMBER 2003-REVISED AUGUST 2005



Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

		TEST CONDITION	C	V	T _A =	25°C	–40°C to 8	5°C	
- F	PARAMETER	TEST CONDITION	5	V _{cc}	MIN	TYP MAX	MIN	MAX	UNIT
		I _{OH} = -100 μA		1.65 V to 3.6 V	$V_{CC} - 0.2$		$V_{CC} - 0.2$		
		$I_{OH} = -4 \text{ mA}$		1.65 V	1.29		1.2		
V		I _{OH} =8 mA		2.3 V	1.9		1.7		V
V _{OH}		1 10 m 4		2.7 V	2.2		2.2		v
		I _{OH} = -12 mA		3 V	2.4		2.4		
		I _{OH} = -24 mA		3 V	2.3		2.2		
		I _{OL} = 100 μA		1.65 V to 3.6 V		0.1		0.2	
		$I_{OL} = 4 \text{ mA}$		1.65 V		0.24		0.45	
V _{OL}		I _{OL} = 8 mA		2.3 V		0.3		0.7	V
		I _{OL} = 12 mA		2.7 V		0.4		0.4	
		I _{OL} = 24 mA		3 V		0.55		0.55	
I _I	Control inputs	$V_{I} = 0$ to 5.5 V		3.6 V		±1		±5	μA
I _{off}		$V_1 \text{ or } V_0 = 5.5 \text{ V}$		0		±1		±10	μA
$I_{OZ}^{(1)}$		$V_0 = 0$ to 5.5 V		3.6 V		±1		±10	μA
		$V_{I} = V_{CC}$ or GND		2.6.1/		1		10	۸
I _{CC}		$3.6 \text{ V} \le \text{V}_1 \le 5.5 \text{ V}^{(2)}$	$I_0 = 0$	3.6 V		1		μA	
ΔI_{CC}	One input at $V_{CC} - 0.6 V$, Other inputs at V_{CC} or GND)	2.7 V to 3.6 V	500			500	μΑ
Ci	Control inputs	$V_I = V_{CC}$ or GND	3.3 V		4			pF	
Cio	A or B port	$V_{I} = V_{CC}$ or GND		3.3 V		5.5			pF

(1) For I/O ports, the parameter I_{OZ} includes the input leakage current. (2) This applies in the disabled state only.

Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	V	T,	_A = 25°C)	-40°C to	o 85°C	UNIT
PARAMETER	(INPUT)	(OUTPUT)	V _{cc}	MIN	TYP	MAX	MIN	MAX	UNIT
			$1.8~V\pm0.15~V$	1	6	12.2	1	12.7	
t _{pd}	A or D	B or A	$2.5~\text{V}\pm0.2~\text{V}$	1	3.9	7.8	1	8.3	~~
	A or B	BOLA	2.7 V	1	4.2	7.1	1	7.3	ns
			$3.3~\textrm{V}\pm0.3~\textrm{V}$	1.5	3.8	6.1	1.5	6.3	
	ŌE		$1.8~V\pm0.15~V$	1	7	14.8	1	15.3	ns
		A or B	$2.5~\textrm{V}\pm0.2~\textrm{V}$	1	4.5	10	1	10.5	
t _{en}			2.7 V	1	5.4	9.3	1	9.5	
			$3.3~\textrm{V}\pm0.3~\textrm{V}$	1.5	4.4	8.3	1.5	8.5	
			$1.8 \text{ V} \pm 0.15 \text{ V}$	1	7.8	16.5	1	17	ns
	OE	A	$2.5~\textrm{V}\pm0.2~\textrm{V}$	1	4	9	1	9.5	
t _{dis}	OE	A or B	2.7 V	1	4.4	8.3	1	8.5	
			$3.3~\textrm{V}\pm0.3~\textrm{V}$	1.7	4.1	7.3	1.7	7.5	
t _{sk(o)}			$3.3 \text{ V} \pm 0.3 \text{ V}$					1	ns

Operating Characteristics

 $T_A = 25^{\circ}C$

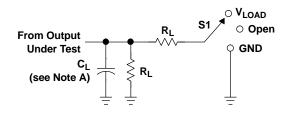
	PARAMETER	TEST CONDITIONS	V _{cc}	ТҮР	UNIT	
			1.8 V	42		
		Outputs enabled	(40 MIL-	2.5 V	43	pF
~				3.3 V	45	
C _{pd}	Power dissipation capacitance per transceiver		f = 10 MHz	1.8 V	1	
		Outputs disabled		2.5 V	1	
				3.3 V	2	

SN74LVC245A-EP OCTAL BUS TRANSCEIVER WITH 3-STATE OUTPUTS

SCAS741B-DECEMBER 2003-REVISED AUGUST 2005



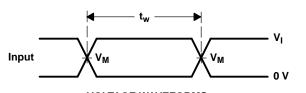
PARAMETER MEASUREMENT INFORMATION



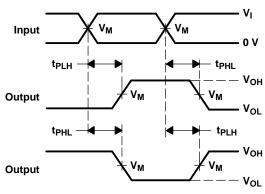
LOAD CIRCUIT

TEST	S1
t _{PLH} /t _{PHL}	Open
t _{PLZ} /t _{PZL}	VLOAD
t _{PHZ} /t _{PZH}	GND

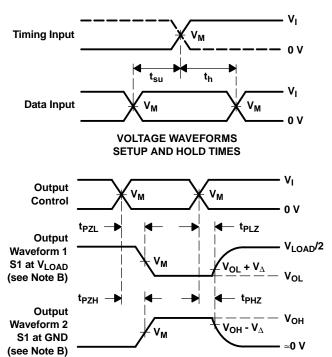
	INF	PUTS			•	-	
V _{CC}	cc VI		V _M	V _{LOAD}	CL	RL	V_{Δ}
1.8 V \pm 0.15 V	V _{CC}	≤2 ns	V _{CC} /2	$2 \times V_{CC}$	30 pF	1 k Ω	0.15 V
2.5 V \pm 0.2 V	V _{CC}	≤2 ns	V _{CC} /2	$2 \times V_{CC}$	30 pF	500 Ω	0.15 V
2.7 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V
3.3 V \pm 0.3 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V



VOLTAGE WAVEFORMS PULSE DURATION



VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES LOW- AND HIGH-LEVEL ENABLING

- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω .
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en}.
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 - H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



10-Dec-2020

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LVC245AIPWREP	ACTIVE	TSSOP	PW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	C245AEP	Samples
V62/04737-01XE	ACTIVE	TSSOP	PW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	C245AEP	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.



www.ti.com

PACKAGE OPTION ADDENDUM

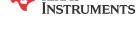
10-Dec-2020

OTHER QUALIFIED VERSIONS OF SN74LVC245A-EP :

• Catalog: SN74LVC245A

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

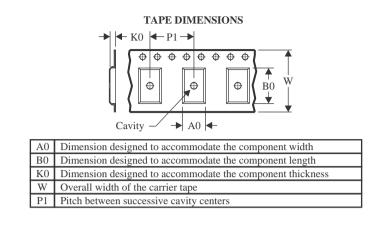


Texas

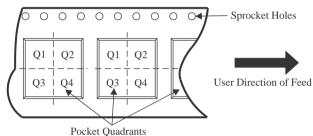
www.ti.com

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LVC245AIPWREP	TSSOP	PW	20	2000	330.0	16.4	6.95	7.0	1.4	8.0	16.0	Q1



www.ti.com

PACKAGE MATERIALS INFORMATION

3-Jun-2022



*All	dimensions	are	nominal	
------	------------	-----	---------	--

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LVC245AIPWREP	TSSOP	PW	20	2000	356.0	356.0	35.0

PW0020A



PACKAGE OUTLINE

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.

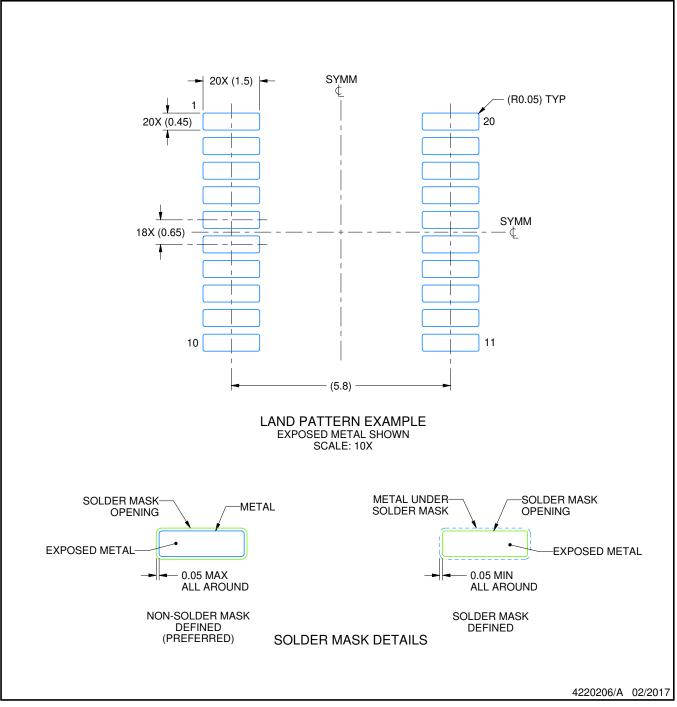


PW0020A

EXAMPLE BOARD LAYOUT

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



PW0020A

EXAMPLE STENCIL DESIGN

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



LAND PATTERN DATA



NOTES: Α. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
 C. Publication IPC-7351 is recommended for alternate design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2022, Texas Instruments Incorporated